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	) 18.83.4 (19.1) 8.00 (11.1)	Attorney Docket No.: 81751.0012	
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Add	litional name(s) of conveying party(ies) attached? 🔲 Yes 🔯 🐧		
3.	Nature of conveyance:	and	
		Tadahiro OHMI 2-1-17-301Komegahukuro, Aoba-ku,	
	Execution Date: September 3, 2001	Sendai-shi, Miyagi-ken, Japan	
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> PATENT REEL: 012144 FRAME: 0578

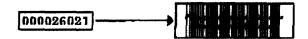
## ASSIGNMENT

WHEREAS, I. HIRUYUKI SHIMADA, Kofu-shi, Yamanashi-ken, Japan, for good and valuable consideration, receipt of which is hereby acknowledged, hereby assign to, SEIKO EPSON CORPORATION, a corporation of Japan having a place of business at 4-1, Nishi-shinjuku 2-chome, Shinjuku-ku, Tokyo, Japan, and to its successors, assigns, and legal representatives, my entire right, title, and interest in and to United States Patent Application Serial No. 09/834,992, filed April 12, 2001, and entitled "SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME" and in and to all corresponding Letters Patent, and all Convention and treaty rights of all kinds, in all countries throughout the world, to be held by SEIKO EPSON CORPORATION as a co-owner of the invention along with my joint inventor, TADAHIRO OHMI, Sendai-shi, Miyagi-ken, Japan, each said co-owner to have an undivided one-half interest to the invention.

- 1) The undersigned agree(s) to execute all papers necessary in connection with any original, reissue, divisional, and continuing United States and foreign applications for the aboveidentified invention and also to execute separate assignments in connection with such applications as the owners of those applications and any patents that issue from them deem necessary or expedient.
- 2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application, or any continuation or divisional thereof, and to cooperate with the owners of such applications or patents in every way possible in obtaining evidence and going forward with such interference.
- 3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.
- 4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the owners of the invention.
- 5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patent of the United States resulting from said application or any

PATENT REEL: 012144 FRAME: 0579 divisional or continuing applications thereof to the patent's owners, as Assignee of the entire interest, and hereby covenants that he has full right to convey the entire interest herein assigned, and that he has not executed any agreement in conflict herewith.

6) The undersigned hereby appoint(s) the persons associated with Customer Number:



the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

I agree to do all acts and sign all documents necessary to secure, defend, and maintain this international patent application, and all such national and/or regional patent applications in accordance with this assignment.

Date: Sep. 3, 200/

Hiroyuki Shimada